DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

ATTORNEY DOCKET NO. 10011880-1

As a below named inventor, I hereby declare that:

My residence/post office address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

Methods and Systems			ductor Substrate Co	ontaining Microelectronics			
the specification of w	hich is att	ached hereto unless tl	ne following box is	checked:			
() was filed on	as US Application No. or PCT International Application						
Number	and was amended on (if applicable).						
I hereby state that I including the claims.	have revie	ewed and understood	the contents of the	e above-identified specification ve. I acknowledge the duty			
inventor(s) certificate listed	ity benefits below and	under Title 35, United Stat	ny foreign application fo	any foreign application(s) for patent r patent or inventor(s) certificate havi			
COUNTRY		APPLICATION NUMBER	DATE FILED	PRIORITY CLAIMED UNDER 35 U.S C 119			
				YES: NO:			
				YES: NO:			
Provisional Application I hereby claim the benefit below:	under Title (35, United States Code Sec		d States provisional application(s) list			
		APPLICATION NUMBER	FILING DATE				
information as defined in Title 37, Code of Federal Regulation application and the national or PCT international filing date of APPLICATION NUMBER FILING DATE		ernational filing date of this	this application: STATUS (patented/pending/abandoned)				
POWER OF ATTORNEY:							
As a named inventor, I h	ereby appoi Trademark	nt the following attorney(s Office connected therewith:) and/or agent(s) to pro	secute this application and transact			
Customer Number 0228		022879	Place Customer Number Bar Code Label here				
Send Correspondence	to:		Direct Telephone Calls To:				
HEWLETT-PACKARD COMPANY Intellectual Property Administration			Lucinda Auc	iello			
P.O. Box 272400 Fort Collins, Colorado 80527-2400			(541) 715-7036				
made on information with the knowledge imprisonment, or both	and bel that wil	ief are believed to be Iful false statements	true; and further the and the like so ne 18 of the United S	are true and that all statement nat these statements were ma nade are punishable by fine states Code and that such will tent issued thereon.			
Full Name of Inventor: S	hen Busw	ell	Citizenship: L	JSA			
Residence:	1699 Teton Drive, Monmouth, Oregon 97361						
Post Office Address:	Same as Residence						
-							

Date

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DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION (continued)

ATTORNEY DOCKET NO. 10011880-1

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Inventor's Signature		Date					
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Residence:	1448 SW Birdie Drive, Corv	rallis, Oregon	9/333				
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Inventor's Signature		Date					
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Residence:	OI .						
Post Office Address:							
Inventor's Signature		Date					
		•					
Full Name of # 8 joint invent	tor:		Citizenship:				
Residence:							
Post Office Address:							
Inventor's Signature		Date					